

# **AQ-102LV**

Arc flash protection device

# Instruction manual



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#### Version: 1.04

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#### Disclaimer

Please read these instructions carefully before using the equipment or taking any other actions with respect to the equipment. Only trained and qualified persons are allowed to perform installation, operation, service or maintenance of the equipment. Such qualified persons have the responsibility to take all appropriate measures, including e.g. use of authentication, encryption, anti-virus programs, safe switching programs etc. necessary to ensure a safe and secure environment and usability of the equipment. The warranty granted to the equipment remains in force only provided that the instructions contained in this document have been strictly complied with.

Nothing contained in this document shall increase the liability or extend the warranty obligations of the manufacturer Arcteq Relays Ltd. The manufacturer expressly disclaims any and all liability for any damages and/or losses caused due to a failure to comply with the instructions contained herein or caused by persons who do not fulfil the aforementioned requirements. Furthermore, the manufacturer shall not be liable for possible errors in this document.

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# 1 Document information

Table. 1 - 1. History of Revision 1.

Revision	1.00
Date	September 2020
Changes	- The first revision of the manual.
Revision	1.01
Date	January 2023
Changes	<ul> <li>Updated the Arcteq logo on the cover.</li> <li>Updated the distance between the flash and the unit in the "Testing the unit operation time" chapter.</li> <li>Unified terminology used througout the manual (e.g. unit and device means the same thing. Now all AQ 100 series relays are called "devices").</li> <li>Improved many existing drawings.</li> <li>Rearranged topics into a more logical order.</li> <li>Added connection drawings to input and output descriptions under "Connections" chapter.</li> <li>Added hyperlinks to chapters. (e.g. "See <u>Device features</u> chapter for more information")</li> <li>Listed more features in <u>Device features</u> chapter.</li> <li>T3 is now considered to be normally open by default and normally closed as an order option.</li> <li>Added information about binary output pulse messages.</li> <li>Many tables have been simplified and made easier to read.</li> <li>Scheme matrixes and simplified logic diagrams have been made more detailed in "Available schemes" chapter.</li> </ul>
Revision	1.02
Date	April 2023
Changes	- Small changes to visual style Small improvements to descriptions.
Revision	1.03
Date	September 2024
Changes	- Improved dimensions and installation description.
Revision	1.04
Date	March 2025
Changes	<ul> <li>- Added a description of the fiber input sensitivity option to the <u>Arc sensor channels</u> chapter.</li> <li>- Updated the <u>Ordering information</u> chapter.</li> </ul>

# 2 Safety information

This document contains important instructions that should be saved for future use. Read the document carefully before installing, operating, servicing, or maintaining this equipment. Please read and follow all the instructions carefully to prevent accidents, injury and damage to property.

Additionally, this document may contain four (4) types of special messages to call the reader's attention to useful information as follows:



#### NOTICE!

"Notice" messages indicate relevant factors and conditions to the the concept discussed in the text, as well as to other relevant advice.



#### **CAUTION!**

"Caution" messages indicate a potentially hazardous situation which, if not avoided, could result in minor or moderate personal injury, in equipment/property damage, or software corruption.



#### WARNING!

"Warning" messages indicate a potentially hazardous situation which, if not avoided, **could** result in death or serious personal injury as well as serious damage to equipment/property.



#### DANGER!

"Danger" messages indicate an imminently hazardous situation which, if not avoided, will result in death or serious personal injury.

These symbols are added throughout the document to ensure all users' personal safety and to avoid unintentional damage to the equipment or connected devices.

Please note that although these warnings relate to direct damage to personnel and/or equipment, it should be understood that operating damaged equipment may also lead to further, indirect damage to personnel and/or equipment. Therefore, we expect any user to fully comply with these special messages.

### 3 Abbreviations

AQD – arc quenching device

BI – binary input

BO – binary output

CB - circuit breaker

CBFP - circuit breaker failure protection

CT – current transformer

EPROM – erasable, programmable read-only memory

HSO – high-speed output

LED – light emitting diode

LV – low-voltage

MV – medium-voltage

NC - normally closed

NO - normally open

PCB - printed circuit board

RF – radio frequency

Rx – receiver

SAS – standard arc scheme

SF – system failure

Tx - transceiver

μP - microprocessor

### 4 General

The AQ-102LV is a sophisticated microprocessor-based arc flash protection device with fiber loop sensor channels. The device is designed to minimize the damage caused by an arc fault. This is done by tripping the circuit breaker which supplies current to the fault when fiber loops detect arc light.

The device includes a complete system self-supervision functionality of which provides the highest level of dependability as it continuously monitors all internal system functions as well as all external connections.

Figure. 4 - 1. Arc protection device AQ-102LV.



The AQ-102LV is designed according to the latest protection relay standards and is therefore suitable for installations in rough environments. These include utilities and power plants (both traditional and renewable), various heavy industry applications (off-shore, marine, oil, gas, mining, steel, etc.) as well as commercial and institutional electrical systems. While AQ-102LV is suitable for MV use, it is designed for LV switchgears and for motor control center applications in both new and retrofitted installations.

### 5 Device features

AQ-102LV is an arc flash protection device which can be applied to a variety of applications. It can be used on its own as a stand-alone device, or it can be a part of a more complex arc protection system by using binary inputs and outputs to connect multiple AQ 100 series devices together.

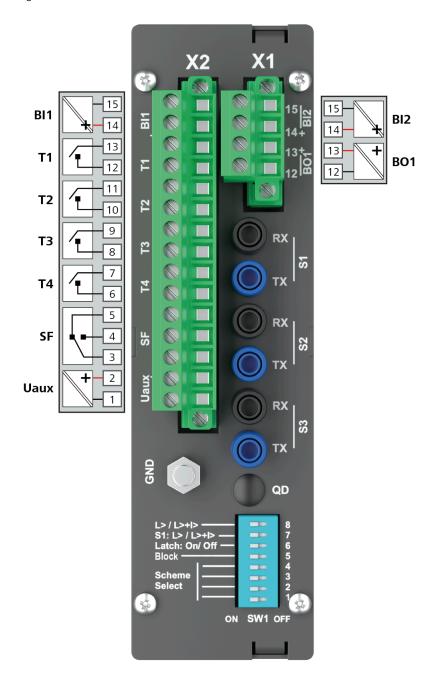
The following list presents the main features of the device:

- 92...265 V AC/DC auxiliary power supply or 18...72 V DC auxiliary power supply (optional)
- three (3) fiber loop channels for arc flash detection
- one (1) fiber connector for arc quenching device control (optional)
- two (2) binary inputs
- four (4) trip relays
- one (1) binary output
- one (1) system failure relay (change-over)
- eleven (11) indication LEDs
- eight (8) DIP switches for logic configuration
- one (1) multifunction push button.

### **6 Connections**

The figure below depicts the connections of AQ-102. Please note that the SF relay is in the deenergized position.

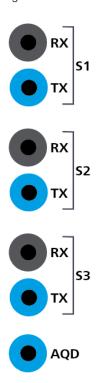
Figure. 6 - 2. Rear terminals of AQ-102LV.



#### 6.1 Inputs

#### 6.1.1 Arc sensor channels

Figure. 6.1.1 - 3. Arc fiber loop sensor and arc quenching device connections.



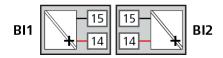
The device has three (3) fiber loop arc sensor channels: S1, S2 and S3. Each channel has a transmitter (Tx) terminal and a receiver (Rx) terminal. These sensor loops are continuously monitored by test light pulses that are sent by the "Tx" channel. If a discontinuity is detected, the device goes into Error mode. See the <a href="System self-supervision">System self-supervision</a> chapter for more information.

The device can be ordered with an additional transmitter (Tx) terminal for arc quenching device (AQD) control. Device sends a test light pulse continuously to the arc quenching device to supervise the fiber connection. If the arc quenching device doesn't receive the test pulses the device will go into Error mode. Alternatively, you can order the device where the input sensitivity of the three fiber loop sensors is low (please refer to the Ordering information chapter).

For more information on sensors, please refer to the Arc sensors chapter.

### 6.1.2 Binary inputs

Figure. 6.1.2 - 4. Binary input connections.



This device has two (2) binary inputs. Typically, the binary inputs are used for receiving arc light signals, master trip commands or overcurrent signals from other AQ 100 series devices. Function of binary inputs are configured using DIP switches. For more information, please refer to the <a href="DIP switch settings">DIP switch settings</a> chapter.

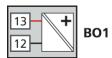
The nominal voltage level of the binary inputs for this device is 24 VDC. Please note that the actual activation threshold of the binary input is at a lower voltage than the specified nominal voltage value (see Techical Data chapter).

AQ 100 series devices are capable of monitoring health of wiring between binary inputs and binary outputs of other AQ 100 series devices in the system. If a binary input loses connection to any of the configured binary outputs, the device will go into Error mode. See <a href="System self-supervision">System self-supervision</a> chapter for more information.

#### 6.2 Outputs

### 6.2.1 Binary outputs

Figure. 6.2.1 - 5. Binary output connection.



The device has one (1) binary output: BO1. AQ 100 series binary outputs have an internal 24 VDC power supply. This binary output is used for sending overcurrent, light detection, master trip and other signals to other AQ 100 series devices in the system. The binary output function can be configured with the DIP switches. For more information on the configuration, please refer to the DIP switch settings chapter.

Binary outputs are capable of generating a short test pulse every second. Binary inputs of the receiving AQ 100 series devices use these pulses to count the number of connected binary outputs. See <a href="System self-supervision">System Self-supervision</a> chapter for more information.

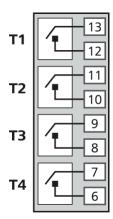


#### NOTICE!

Please note that the binary ouputs are polarity-sensitive.

### 6.2.2 Trip relays

Figure. 6.2.2 - 6. Trip relay connections



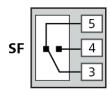
This device has four (4) normally open trip relays. Trip relays T1 and T2 are used for tripping circuit breakers. T4 is generally used for tripping one additional disconnecting device, or as a trip alarm (local or remote) monitoring and alarming system.

T3 can alternatively be ordered as a normally closed relay (electronic lock-out relay). Once opened by fault detection it holds its open position until it receives a manual reset command or until auxiliary power supply is lost. When re-applying the auxiliary power supply, the electronic lock-out relay returns to the same position it had prior to the power loss. This normally closed relay can also be used for tripping contactor-controlled devices.

T3 and T4 are always latching relays. Trip relays T1 and T2 can be set as latching relays with a DIP switch setting (for more information, please refer to the <u>DIP switch settings</u> chapter.

### 6.2.3 System failure relay

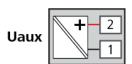
Figure. 6.2.3 - 7. System failure relay connection (de-energized position)



The system failure (SF) relay is of the change-over type (NO/NC) and it is energized when the device is in a healthy condition and powered on. Whenever the device detects a system error or the auxiliary power supply is disconnected, the SF relay changes its state. The state stays this way until the device returns to a healthy condition. See the System self-supervision chapter for more information.

### 6.3 Auxiliary voltage

Figure. 6.3 - 8. Auxiliary power supply connection



The auxiliary power supply voltage is 92...265 V AC/DC. Alternatively, the auxiliary power supply can be of 18...72 V DC. This choice must be specified when ordering.

### 7 Arc sensors

The AQ 100 series suppors arc sensing point sensors and fiber optic loop sensors. These sensors can be used with different devices and different switchgear types according to specific application requirements.

Point sensors are typically installed in metal-clad compartments, and they provide a quick and accurate location of the fault area. Fiber loops typically cover a wider protected area with one fiber, when there is no need to pinpoint the exact location of a fault.

### 7.1 Arc light fiber optic loop sensor AQ-06

AQ-06 is an arc light fiber optic loop sensor, which is a plastic fiber optic cable. Fiber sensors are distributed through the protected switchgear cells. The light intensity threshold of an AQ-06 sensor is 8,000 lux. The sensor's detection radius is 360 degrees.

AQ-06 sensors can be ordered in pre-manufactured lengths of 3...40 meters (3 m, 5 m, 10 m, 15 m, 20 m, 25 m, 30 m, 35 m, 40 m).

### 7.2 Arc light fiber optic loop sensor AQ-07

AQ-07 is an arc light fiber optic loop sensor, which is a robust fiber optic cable with a practically unlimited bending radius. The sensor contains hundreds of glass fiber drains covered by a plastic tube, thus making it extremely strong and durable. Fiber sensors are distributed through the protected switchgear cells.

AQ-07 sensors can be ordered in pre-manufactured lengths of 3...50 meters (3 m, 5 m, 10 m, 15 m, 20 m, 25 m, 30 m, 35 m, 40 m, 45 m, 50 m).

The light intensity threshold of an AQ-07 sensor is 8,000 lux. The sensor's detection radius is 360 degrees.

If necessary, the ends of an AQ-07 cable can be ordered with heat shrinking tubing to avoid light detection outside the protected zone. The covered area can be one (1) or two (2) meters by default; if other lengths are required, please consult the Arcteq sales team. You can find the <a href="Contact and reference information">Contact and reference information</a> chapter at the end of this manual.

### 7.3 Arc light fiber optic loop sensor AQ-08

AQ-08 is an arc light fiber optic loop sensor. It is designed to withstand temperatures up to 125 °C, which makes it suitable for e.g. wind turbine windings. AQ-08 is a robust fiber optic cable with a practically unlimited bending radius. The sensor contains hundreds of glass fiber drains that are covered by a plastic tube, thus making it extremely strong and durable. Fiber sensors are distributed through the protected switchgear cells.

AQ-08 sensors can be ordered in pre-manufactured lengths of 3...15 meters (3 m, 5 m, 10 m, 15 m).

The light intensity threshold of an AQ-08 sensor is 8,000 lux. The sensor's detection radius is 360 degrees.

# 7.4 Sensor dependencies

Compatibility of arc sensor types depend on the hardware available in the AQ 100 series device. The table below describes those dependencies.

Table. 7.4 - 2. Sensor dependencies.

	Point sensors (AQ-01 & AQ-02)	Fiber loops (AQ-06, AQ-07 & AQ-08)
AQ-101LV	Yes	Order option
AQ-101DLV	Yes	Order option
AQ-102LV	No	Yes
AQ-103LV	Yes	Order option
AQ-110PLV	Yes	Order option
AQ-110FLV	No	Yes

# 8 Operation and configuration

### 8.1 DIP switch settings

Configuration of the operation logic and other functionalities are done with DIP switches. The DIP switches are located at the back of the device.

Main operation logic can be defined with "Scheme selection" DIP switches. Logic schemes are described in the <u>Logic schemes</u> chapter.

Tripping can be set with DIP switches to require either just arc light ("Light only" mode) or both arc light and overcurrent simultaneously ("Light and current" mode). Adding overcurrent criteria ensures the device trips when an arc fault occurs but not when a strong natural light source hits the light sensor (e.g. sunlight). Overcurrent signal comes from external devices (mainly other AQ 100 series devices) and are connected to a binary input.

Figure. 8.1 - 9. DIP switch diagram.

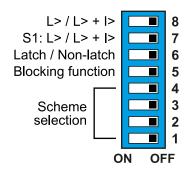


Table. 8.1 - 3. DIP switch settings.

Switch	Function selection	ON (left position)	OFF (right position)	
8	The tripping criterion for the S2 and S3 sensor channels.	Tripping on light only (L>).	Light detection only trips if overcurrent is	
7	The tripping criterion for the S1 sensor channel.		also detected at the same time (L> + I>).	
6	Enables or disables latching of T1 and T2 trip relays.	T1 and T2 operate as latching relays.	T1 and T2 latching is disabled.	
5	Selects the function of binary input 1 or 2 (depends on the selected logic scheme).	The blocking function is selected. All trip signals (T1T4) and the arc quenching device control (AQD) are blocked when the binary input is active.	Overcurrent function is selected. Binary input must be active simultaneously with light detection for tripping to occur and for arc quenching device control (AQD) to activate.	

Swi	tch Function selection	ON (left position)	OFF (right position)
4–1	Scheme selection. Please refer to the Logic schemes chapter.	Switch 1: 1 Switch 2: 2 Switch 3: 4 Switch 4: 8	Switch 1: 0 Switch 2: 0 Switch 3: 0 Switch 4: 0



#### NOTICE!

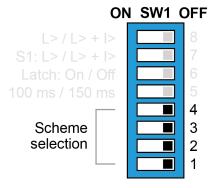
The T3 and T4 trip relays are always latching. The BO1 binary output function is never latching.

### 8.2 Logic schemes

The schemes described below are the most commonly used ones for AQ-101 devices. However, additional schemes are also available; please contact your nearest Arcteq representative for more information on those schemes. The schemes are configured using the DIP switches numbered 1...4 ("Scheme selection"). The scheme selection is based on binary arithmetic:

- Switch 1: 1
- Switch 2: 2
- Switch 3: 4
- Switch 4: 8

Figure. 8.2 - 10. DIP switches used for selecting the logic scheme.



AQ 100 series arc protection devices can be used as a stand-alone device or as a part of a more complex arc portection system with multiple AQ 100 series devices. The most convenient way to set the device to a more complex arc protection system is to use Standard Arc Schemes (SAS). For detailed instructions on each of the available Standard Arc Schemes please refer to the AQ-SAS™ booklet (can be found at arcteq.fi/downloads/).

#### 8.2.1 SS:0

The logic scheme SS:0 can be applied as a non-selective arc protection scheme. If any of the light sensor channels detect light, all trip contacts are closed and BO1 sends a light signal to any connected external devices. Position of "Blocking function" DIP-switch defines if BI2 is used for receiving current signals from external devices or for blocking activation of trip relays. AQ-110 can send a master trip command to BI1 of the AQ-102LV device. BI1 is a master trip signal received from incoming feeder arc protection device.

Figure. 8.2.1 - 11. SS:0 example application.

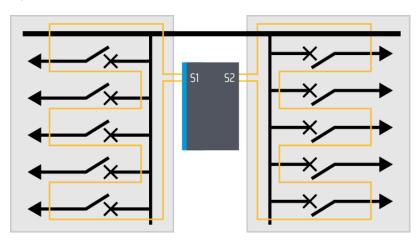
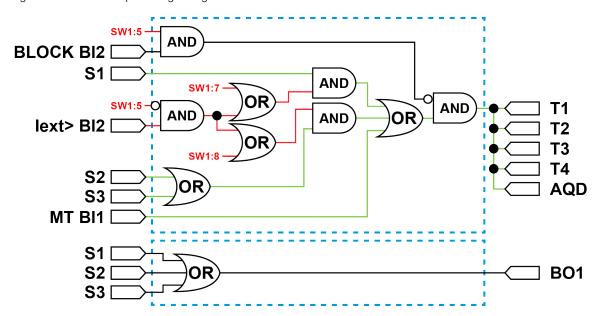


Figure. 8.2.1 - 12. Logic matrix of SS:0.

00.0		OUTPUTS					
	55:0	T1 <sup>2</sup>	T2 <sup>2</sup>	T3 <sup>2</sup>	T4 <sup>2</sup>	BO1	AQD <sup>2</sup>
UTS	S1 - S3	$\mathbf{x}^1$	x <sup>1</sup>	x <sup>1</sup>	x <sup>1</sup>	Х	x <sup>1</sup>
INP	Master trip (BI1)	х	х	х	х		х

- 1. If the "Blocking function" DIP-switch is OFF, the binary input BI2 can be used to receive an external current signal. The tripping criterion can be selected to be light only (L>) or both light and current (L> + I>).
- 2. If the "Blocking function" DIP-switch is ON, the activation of BI2 blocks activation.

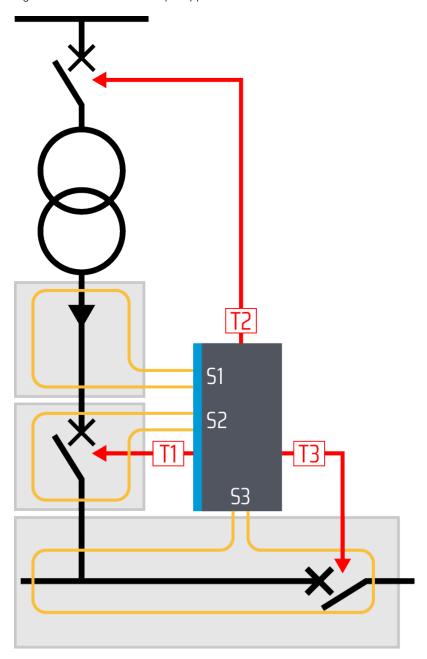
Figure. 8.2.1 - 13. Simplified logic diagram of SS:0.



#### 8.2.2 SS:1

The logic scheme SS:1 is designed for selective incoming feeder arc protection without current detection. It can be used for substations with one incoming feeder.

Figure. 8.2.2 - 14. SS:1 example application.



If a fault is detected in the incoming feeder cable compartment (S1), circuit breakers on both sides of the transformer will be tripped with T1 and T2.

If a fault is detected in the incoming feeder circuit breaker compartment (S2), circuit breakers on both sides of the transformer (T1-T2) and tie breaker (T3) will be tripped. If a fault is detected in the busbar compartment or in the tie breaker compartment (S3) or light signal is received from an external device (BI2) the incoming feeder (T1) and the tie breaker (T3) will be tripped.

Position of "Blocking function" DIP switch defines if BI1 is used for receiving current signals from external devices or for blocking activation of trip relays.

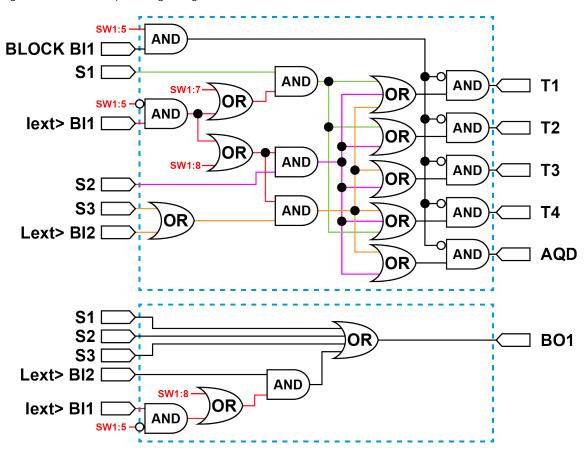
The binary output BO1 is responsible for sending light detection signal to any external device(s) at outgoing feeders.

Figure. 8.2.2 - 15. Logic matrix of SS:1.

SS:1		OUTPUTS						
		T1 <sup>2</sup>	T2 <sup>2</sup>	T3 <sup>2</sup>	T4 <sup>2</sup>	BO1	AQD <sup>2</sup>	
	<b>S1</b>	x <sup>1</sup>	x <sup>1</sup>		x <sup>1</sup>	х		
UTS	S2	x <sup>1</sup>	x <sup>1</sup>	x <sup>1</sup>	x <sup>1</sup>	х	x <sup>1</sup>	
INP	\$3	x <sup>1</sup>		x <sup>1</sup>	x <sup>1</sup>	х	x <sup>1</sup>	
	Lext> (BI2)	x <sup>1</sup>		x <sup>1</sup>	x <sup>1</sup>	x <sup>1</sup>	x <sup>1</sup>	

- 1. If the "Blocking function" DIP switch is OFF, the binary input BI1 can be used to receive an external current signal. The tripping criterion can be selected to be light only (L>) or both light and current (L> + I>).
- 2. If the "Blocking function" DIP switch is ON, the activation of BI1 blocks activation.

Figure. 8.2.2 - 16. Simplified logic diagram of SS:1.



#### 8.2.3 SS:2

This scheme is similar to SS:0. In this scheme BI1 is used for resetting latched trip relays and LEDs remotely. If there's a need for receiving a light signal from an external device, use SS:0 instead.

The logic scheme SS:2 can be applied as a non-selective arc protection scheme. If any of the light sensor channels detect light, all trip contacts are closed and BO1 sends a light signal to any connected external devices. Position of "Blocking function" DIP switch defines if BI2 is used for receiving current signals from external devices or for blocking activation of trip relays.

Figure. 8.2.3 - 17. SS:2 example application.

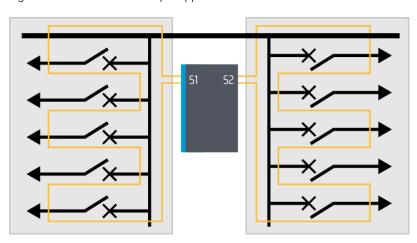


Figure. 8.2.3 - 18. Logic matrix of SS:2.

CC		OUTPUTS							
55	:2	T1 <sup>2</sup>	T2 <sup>2</sup>	T3 <sup>2</sup>	T4 <sup>2</sup>	BO1	AQD <sup>2</sup>		
INPUTS	S1 - S3	$x^1$	$x^1$	x <sup>1</sup>	$x^1$	Х	x <sup>1</sup>		

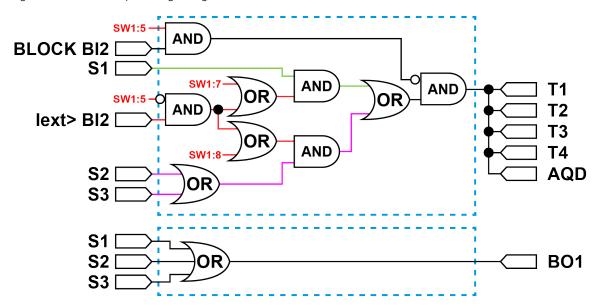
- 1. If the "Blocking function" DIP switch is OFF, the binary input BI2 can be used to receive an external current signal. The tripping criterion can be selected to be light only (L>) or both light and current (L> + I>).
- 2. If the "Blocking function" DIP switch is ON, the activation of BI2 blocks activation.



#### NOTICE!

In this scheme, the binary input BI1 is used as the input for resetting latched trip relays and LEDs.

Figure. 8.2.3 - 19. Simplified logic diagram of SS:2.



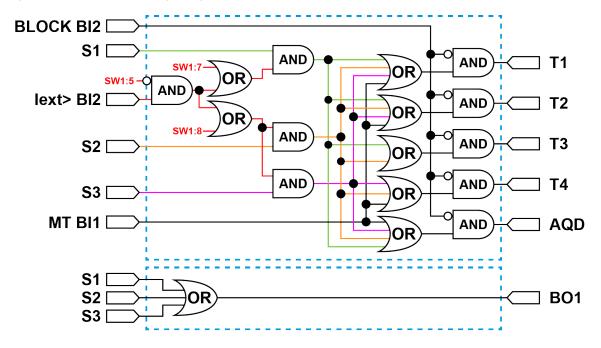
#### 8.2.4 SS:3

Figure. 8.2.4 - 20. Logic matrix of SS:3.

SS:3		OUTPUTS						
		T1 <sup>2</sup>	T2 <sup>2</sup>	T3 <sup>2</sup>	T4 <sup>2</sup>	BO1	AQD <sup>2</sup>	
	<b>S1</b>	$\mathbf{x}^1$	x <sup>1</sup>	x <sup>1</sup>		х	x <sup>1</sup>	
UTS	S2	x <sup>1</sup>	x <sup>1</sup>	x <sup>1</sup>	x <sup>1</sup>	х	x <sup>1</sup>	
INPU	<b>S3</b>	x <sup>1</sup>	x <sup>1</sup>		x <sup>1</sup>	х	x <sup>1</sup>	
	Master trip (BI1)	Х	х		х		х	

- 1. If the "Blocking function" DIP switch is OFF, the binary input BI2 can be used to receive an external current signal. The tripping criterion can be selected to be light only (L>) or both light and current (L> + I>).
- 2. If the "Blocking function" DIP switch is ON, the activation of BI2 blocks activation.

Figure. 8.2.4 - 21. Simplified logic diagram of SS:3.



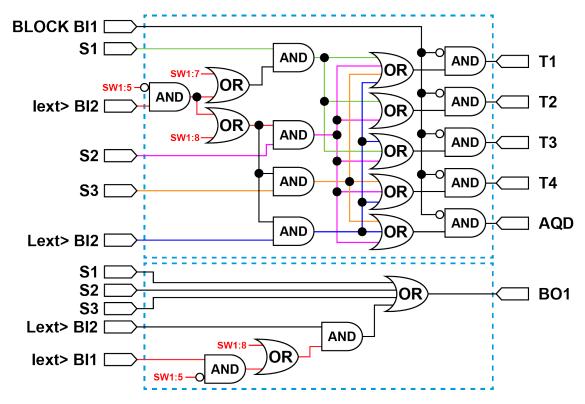
#### 8.2.5 SS:4

Figure. 8.2.5 - 22. Logic matrix of SS:4.

SS:4		OUTPUTS						
		T1 <sup>2</sup>	T2 <sup>2</sup>	T3 <sup>2</sup>	T4 <sup>2</sup>	BO1	AQD <sup>2</sup>	
	<b>S1</b>	$\mathbf{x}^1$	$\mathbf{x}^{1}$	$\mathbf{x}^1$		х		
UTS	<b>S2</b>	x <sup>1</sup>	$\mathbf{x}^{1}$	$\mathbf{x}^{1}$	x <sup>1</sup>	х	x <sup>1</sup>	
INPU	\$3	x <sup>1</sup>			x <sup>1</sup>	x	x <sup>1</sup>	
	Lext>(BI2)	$\mathbf{x}^{1}$		$\mathbf{x}^1$	x <sup>1</sup>	x <sup>1</sup>	x <sup>1</sup>	

- 1. If the "Blocking function" DIP switch is OFF, the binary input BI1 can be used to receive an external current signal. The tripping criterion can be selected to be light only (L>) or both light and current (L> + I>).
- 2. If the "Blocking function" DIP switch is ON, the activation of BI1 blocks activation.

Figure. 8.2.5 - 23. Simplified logic diagram of SS:4.



### 8.3 Push button (SET)

The device has one push button, SET, and it can be used for all operational functions. The push button is used for:

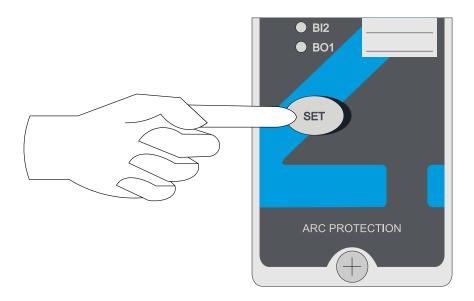
- 1. Setting up the system (also known as auto-configuration)
- 2. Resetting the indicator LEDs
- 3. Resetting latched outputs
- 4. Checking the input connections



#### WARNING!

Do <u>NOT</u> use force when pushing the button, as this may cause the button to lodge deep inside the chassis!

Figure. 8.3 - 24. The "SET" push button on the device's front panel.



#### 8.3.1 System setup (auto-configuration)

After DIP switches have been set to correct position and all sensors, binary inputs and binary outputs have been connected, a system setup procedure (also known as auto-configuration) must be performed. The sequence is initialized by pressing the SET push button for two seconds. This causes the sensor and binary I/O LEDs to start blinking. The device scans these inputs to see if they are connected; when an input is detected, the corresponding LED lights up to indicate that a connection was found. All inputs that are not connected continue to blink for three more seconds. Then, all LEDs are turned off. Additionally, the DIP switch setting are stored in the non-volatile memory after this sequence.

If the device detects any deviation from the saved configuration, self supervision system issues an alarm. See System self-supervision chapter for more information.

All arc sensors are operational even when they have not been auto-configured. System setup is only used for self-supervision purposes.

#### NOTICE!



Please note that to reconfigure a device with fewer connections (BI or arc sensors) than in the previously memorized setup, one of the DIP switches must be moved back and forth once before the system setup procedure is carried out. You can reconfigure a device with more connections at any time without having to move one of the DIP switches.

#### 8.3.2 Reset

All LED indications and latched trip relays can be reset by pressing the SET push button.

#### 8.3.3 Input connection check

After the system setup (auto-configuration) procedure is completed, you can verify the connectivity of arc sensors and binary input channels by pressing the SET push button three (3) times within two (2) seconds. The LEDs of the corresponding arc sensors, binary input channels and the "Power" LED start blinking. The LEDs blink as many times as there are connected sensors and binary output channels from other devices.

#### 8.4 LED indicator functions

The AQ-102LV device has eleven (11) indication LEDs on the device's front panel. Apart from the "Power" and "Error" LEDs, the user can write their own identifications for each of the remaining LEDs on the text insert located in the transparent pocket next to the LEDs.

When the device is powered up, it performs an LED test. All LEDs turn on for two (2) seconds and then turn off; only the blue "Power" LED stays on.

When the device operates normally, only the blue "Power" LED is lit.

If an arc sensor is activated, its corresponding LED turns on. Activated arc sensor LEDs will stay on until user has reset them with "SET" push button.

If there is a loose sensor wire or if the self-supervision function detects a configuration mismatch (that is, a new sensor has been attached but the auto-configuration system setup has not been run), the corresponding LED starts flashing and the "Error" LED activates.

The binary I/O LEDs indicate the status of the input and output lines. If any of the lines become active, the corresponding LED turns on. All light channel and trip indication LEDs are latched, even if the DIP switch settings are in the non-latched mode.

All LED indications are stored in the non-volatile memory (EPROM) to help identify the necessary trip information even after auxiliary power is lost. When the device is re-powered after a power supply loss, the front panel shows the status of all LEDs.

You can clear the LEDs by pushing the SET button.

### 8.5 LED operations guide

Table. 8.5 - 4. LED operation descriptions.

LED name (color)	Light off	Steady light	Blinking light	Action if abnormal
POWER (blue)	The auxiliary power supply is disconnected.	The auxiliary power supply is connected.	(N/A)	Check the power supply.
ERROR (red)	The system is healthy.	A system failure has occured.	A configuration mismatch has been detected. Protection is partially operational.	Verify the system condition (see the <u>System self-supervision</u> and <u>Troubleshooting</u> chapters).
T1–T4 (red)	Normal status.	The trip relay in question has activated.	(N/A)	Check what caused the trip, clear the fault and reset the indicator LEDs with the push button.

LED name (color)	Light off	Steady light	Blinking light	Action if abnormal
S1-S3 (amber)	Normal status.	The fiber sensor channel has activated.	The fiber sensor has dropped off or a system setup has not been performed.	Check the sensor continuity or perform a system setup (see the System setup chapter); or, check what activated the sensor.
AQD (amber)	Normal status.	The AQD (arc quenching device) channel has been activated.	The fiber connection to the AQD (arc quenching device) has dropped off or a system setup has not been performed.	Check the fiber connection and/or the system configuration.
BI1-BI2 (amber)	Normal status.	The binary input has been activated.	The binary input has a loose connection.	Check the binary input wiring.
BO1 (amber)	Normal status.	The binary output has been activated.	(N/A)	_

### 8.6 Non-volatile memory

All critical system data (such as DIP switch settings and the system setup file) are stored in the non-volatile memory (EPROM) to ensure accurate operation and full self-supervision even if auxiliary power is lost temporarily.

Additionally, all LED indications are stored in the non-volatile memory to provide a quick recovery of the system status indication. This feature is especially important if tripping causes the device to lose its auxiliary power.

The non-volatile memory does not require a power supply to maintain the information and it retains the settings and the indications permanently without power.

# 9 System self-supervision

AQ 100 series devices have an extensive self-supervision function, including both internal functions and external connections. The self-supervision function monitors the following:

- power supply
- · hardware
- · software
- binary input connection(s)
- sensor connection(s)
- DIP switch settings

When the device's condition is healthy and is powered on, the "Power" LED is lit and the system failure (SF) relay is energized. If the self-supervision function detects a faulty condition or if the power supply fails, the SF relay is released and the "Error" LED becomes lit.

#### Binary input connection monitoring

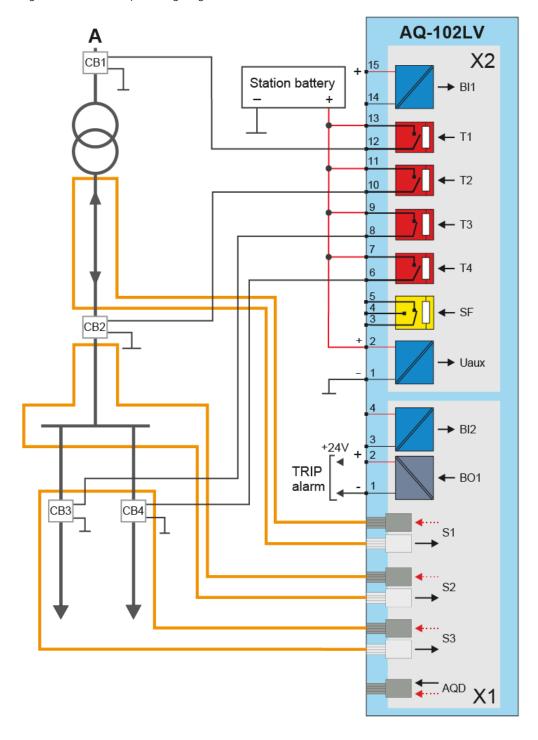
During system setup (auto-configuration) AQ 100 series device checks how many AQ 100 device binary outputs or high-speed outputs have been connected to binary inputs. Each AQ 100 series device binary output and high-speed output constantly sends a short pulse every second which the receiving binary input uses to count the number of connected devices. If any of the outputs are disconnected after the system setup, the binary input will detect the mismatch and the device will go into Error mode and the binary input LED will blink. If the error is resolved, the device automatically clears the system failure status, energizing the SF relay and turning off the "Error" LED.

#### DIP switch setting monitoring

The device goes into Error mode, if a DIP switch setting is changed after the system setup procedure has been performed. However, the configured (stored) settings are still valid and the device is still operational.

# 10 Wiring example

Figure. 10 - 25. Example wiring diagram for AQ-102LV.



# 11 Dimensions and installation

The device can be either door-mounted or panel-mounted in a standard 19 inch rack. The device's dimensions (without connectors) are as follows:

Height: 177 mm (6.97 in)Width: 51 mm (2.00 in)Depth: 168 mm (6.61 in).

The figure below presents the dimension of the device visually. It also shows the dimensions of the cutout (bottom-left) required when mounting the device on a panel.

Figure. 11 - 26. Dimensions of the device and its cut-out panel.

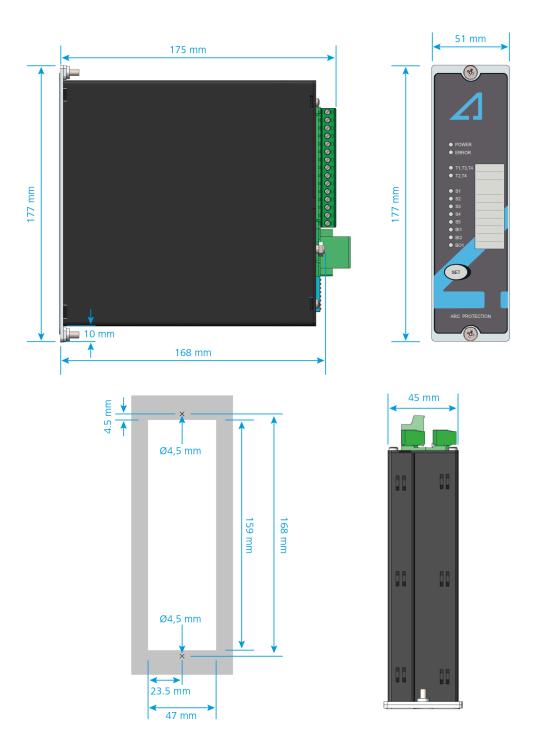
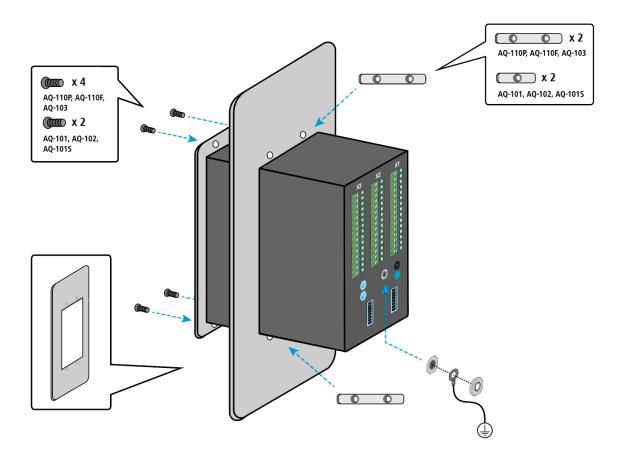


Figure. 11 - 27. Installing a AQ-100 series device to a door.



### 12 Testing

It is recommended that the device is tested prior to substation energizing. Testing is carried out by simulating an arc light for each sensor and verifying that the correct trip contact(s) tripped and that the correct indicator LED(s) turned on.

Any strong camera flash works well to simulate arc light. Please note that small LED lights like smartphone flashes are not strong enough to activate a point sensor or a fiber loop. Having a self-timer helps with the testing process because it can be connected to the test kit. Any strong flashlight works to test non-latched signals and the CBFP function. Before testing please check that the equipment used has a fully charged battery.

### 12.1 Testing the light-only mode

- 1. Check that the DIP switch settings are positioned according to your application.
- 2. Activate the camera flash within 30 cm (12 inches) of the sensor that is being tested.
- 3. Verify that the indicator LED of the corresponding sensor channel is lit.
- 4. Verify the activation(s) of the trip relay(s) by checking the circuit breaker's status, or by monitoring the trip contact's status. The circuit breaker should open, or the contacts operate. Please note that you achieve the best test results when you operate the circuit breaker while testing.
- 5. Verify that the indicator LED(s) of the corresponding trip relay(s) is lit.
- 6. If you are using the BO1 binary output, verify its signal activation either through the status change of the relevant input, or by measuring the signal output voltage. Please note that BO1 is of the non-latched type.
- 7. If you are using the BO1 binary output, also verify that the "BO1" LED is lit.
- 8. Press the SET push button to reset all indications and latches.
- 9. If you are using the BI2 binary input as the master trip, activate it and verify that the trip has occurred by repeating the steps 4 and 5.
- 10. Press the SET push button to reset all indications and latches.
- 11. Repeat the steps 1 through 10 for all sensors.

### 12.2 Testing the light and current mode

- 1. Check that the DIP switch settings are positioned according to your application.
- 2. Activate the following two things simultaneously: the camera flash within 30 cm (12 inches) of the sensor that is being tested, and the binary input used for the overcurrent condition (I>).
- 3. Verify that the indicator LED of the corresponding sensor channel is lit.
- 4. Verify that the indicator LED of the binary input is lit.
- 5. Verify the activation(s) of the trip relay(s) by checking the circuit breaker's status, or by monitoring the trip contact's status. The circuit breaker should open, or the contacts operate. Please note that you achieve the best test results when you operate the circuit breaker while testing.
- 6. Verify that the indicator LED(s) of the corresponding trip relay(s) is lit.
- 7. If you are using the BO1 binary output, verify its signal activation either through the status change of the relevant input, or by measuring the signal output voltage. Please note that BO1 is of the non-latched type.
- 8. If you are using the BO1 binary output, also verify that the "BO1" LED is lit.
- 9. Activate the camera flash within 30 cm (12 inches) of the sensor but <u>do not activate</u> the binary input used for the overcurrent condition (I>).
- 10. Verify that no trip has occured and only the indicator LED of the sensor activation is lit.
- 11. If you are using the BO1 signal and have configured it to send light information, verify that it is activated.
- 12. Press the SET push button to reset all indications and latches.

- 13. If you are using a binary input as the master trip, activate it and verify that the trip has occurred by repeating the steps 5 and 6.
- 14. Press the SET push button to reset all indications and latches.
- 15. Repeat the steps 1 through 13 for all sensors.

#### 12.3 Testing the operation time

An operation time test is not required at commissioning as it is performed by the manufacturer both as a type test and as a routine production test. If you want to have more information of these tests, please refer to the routine test reports sent with the AQ-102 device and/or consult your nearest Arcteq representative for the type test reports.

However, if it is deemed necessary, you can conduct an on-site timing test with the following instructions.

- 1. Use a calibrated relay test set.
- 2. Connect one of the test set's outputs to a strong camera flash to initialize the flash and to configure the set's timer to start simultaneously with the flash.
- 3. Connect one of the AQ-102 device's trip outputs (T1, T2, T3, T4) to a test set input and configure the input to stop the timer.
- 4. Place the camera flash within 30 cm (12 inches) of the sensor.
- 5. Initiate the flash and the timer by using the test set output.
- 6. Read the measured time between the simulated arc light and the operation of the trip contact.
- 7. Subtract the digital input delay of the test set from the final measured time (if applicable). For specific test instructions, please consult the manufacturer of the relay test set.

# 12.4 Test plan example

Basic data	
Date:	
Substation:	
Switchgear:	
Serial number:	



Preconditions		Additional notes
Trip mode (channel 1):	L> L> + I>	
Trip mode (channel 2)	L> L> + I>	
Trip mode (channel 3):	L> L> + I>	
BI master trip in use:	Yes No	
CBFP in use:	Yes No	
CBFP time setting:	100 ms 150 ms	

Object activated	LED active	T1, T2, T3, T4 active	BO1 active	Additional notes
Fiber sensor channel				
Fiber sensor channel 2				
Fiber sensor channel				
Binary input 1				
Binary input 2				

Involved personnel		
Tested by:		
Approved by:		

# 13 Troubleshooting

Table. 13 - 5. Troubleshooting guide for AQ-102.

Problem	Possible solution(s)
The sensor does not activate during testing.	Check the sensor connection.  or  Check the testing equipment, especially the camera flash intensity (see the Testing chapter for more information).
The trip relay does not operate even when the sensor is activated.	Tripping might require overcurrent signal simultaneously with light signal. Check the DIP switch settings (see the "DIP switch settings" chapter for more information).

# 14 Technical data

# 14.1 Operating times

Table. 14.1 - 6. Technical data for relay operating times.

Trip relay operation delay	7 ms*
Reset time (arc light stage)	2 ms

<sup>\*)</sup> The total trip time when using both the arc light (L>) or phase/residual overcurrent (I>) from an AQ-110 device and the arc light (L>) from this device.

### 14.2 Auxiliary voltage

Table. 14.2 - 7. Technical data for the relay auxiliary voltage (Uaux).

Auxiliary power supply	92265 V AC/DC 1872 V DC (optional)
Maximum power consumption	5 W, < 10 mΩ
Standby current	90 mA
Start-up inrush current	<150 ms (110 V DC) <600 ms (24 V DC)

# 14.3 Binary inputs

Table. 14.3 - 8. Technical data for the binary inputs (BI1, BI2).

Nominal threshold voltage	24 V DC
Threshold: - pick-up - drip-off	Approximately 16 V DC Approximately 15 V DC
Rated current	3 mA
Number of inputs	2

### 14.4 Trip relays

Table. 14.4 - 9. Technical data for the trip relays (T1, T2, T3, T4).

Number of trip relays	4 NO <u>or</u> 3 NO + 1 NC
Voltage withstand	250 V AC/DC

Carry: - continuous carry - make-and-carry for 3 s - make-and-carry for 0.5 s	5 A 16 A 30 A
Breaking capacity DC*	40 W (0.36 A at 110 V DC)
Contact material	AgNi 90/10

<sup>\*)</sup> When the time constant L/R = 40 ms.

# 14.5 Binary output(s)

Table. 14.5 - 10. Technical data for the binary output (BO1).

Number of outputs	1
Rated voltage	+24 V DC (internal power supply)
Rated current (max.)	20 mA

# 14.6 System failure relay

Table. 14.6 - 11. Technical data for the system failure relay (SF).

Number of SF relays	1
Rated voltage	250 V AC/DC
Carry: - continuous carry - make-and-carry for 3 s - make-and-carry for 0.5 s	5 A 16 A 30 A
Breaking capacity DC*	40 W (0.36 A at 110 V DC)
Contact material	AgNi 90/10

<sup>\*)</sup> When the time constant L/R = 40 ms.

### 14.7 Fiber optic loop sensors

#### AQ-06 fiber optic loop sensor

Table. 14.7 - 12. Technical data for the AQ-06 fiber optic loop sensor.

Material	Plastic fiber
Light intensity threshold	8,000 lux
Cable length (minmax)	340 m
Cable diameter	1.0 mm

Detection radius	360°
Bending radius	5 cm
Operating temperature	–40+85 °C

#### AQ-07 fiber optic loop sensor

Table. 14.7 - 13. Technical data for the AQ-07 fiber optic loop sensor.

Material	Covered glass fiber
Light intensity threshold	8,000 lux
Cable length (minmax)	350 m
Cable diameter	1.2 mm
Detection radius	360°
Bending radius	1 cm
Operating temperature	–40…+85 °C

### AQ-08 fiber optic loop sensor

Table. 14.7 - 14. Technical data for the AQ-08 fiber optic loop sensor.

Material	Covered glass fiber
Light intensity threshold	8,000 lux
Cable length (minmax)	315 m
Cable diameter	1.2 mm
Detection radius	360°
Bending radius	1 cm
Operating temperature	–40+125 °C

### 14.8 Disturbance tests

Table. 14.8 - 15. Technical data for the disturbance tests.

Electromagnetic compatibility test	CE-approved and tested according to EN 50081-2 and EN 50082-2
Conducted emission (EN 55011, class A)	0.1530.00 Hz
Radiated emission (EN 55011, class A)	30.001,000.00 MHz

Electrostatic discharge immunity (IEC 244-222 and EN 61000-4-2, level 4)	Air discharge: 15 kV Contact discharge: 8 kV
Electrical fast transients (EN 61000-4-4, class III & IEC 801-4, level 4)	Power supply input: 4 kV, 5/50 ns Other inputs and outputs: 4 kV, 5/50 ns
Surge immunity (EN 61000-4-5, level 4)	Between wires: 2 kV, 1.2/50 μs Between wire and earth: 4 kV, 1.2/50 μs
RF electromagnetic field (EN 61000-4-3, level 3)	f = 801,000 MHz, 10 V/m
Conducted RF field (EN 61000-4-6, level 3)	f = 150 kHz80 MHz, 10 V/m

# 14.9 Voltage tests

Table. 14.9 - 16. Technical data for the voltage tests.

Insulation test voltage (IEC 60255-5)	2 kV, 50 Hz, 1 min
Impulse test voltage (IEC 60255-5)	5 kV, 1.2/50 μs, 0.5 J

#### 14.10 Mechanical tests

Table. 14.10 - 17. Technical data for the mechanical tests.

Vibration test	213.2 Hz (± 3.5 mm) 13.2100 Hz (±1.0 g)
Shock/bump test (IEC 60255-21-2)	20 g and 1,000 bumps/dir.

#### 14.11 Environmental conditions

Table. 14.11 - 18. Technical data for the environmental conditions.

Specified ambient service temperature	–35+70 °C
Transportation and storage temperature	-40+70 °C
Relative humidity	Up to 97 %
Altitude	Up to 2,000 m above sea level

### 14.12 Casing

Table. 14.12 - 19. Technical data for the device casing.

Protection:	
- front	IP 50
- back	IP 20

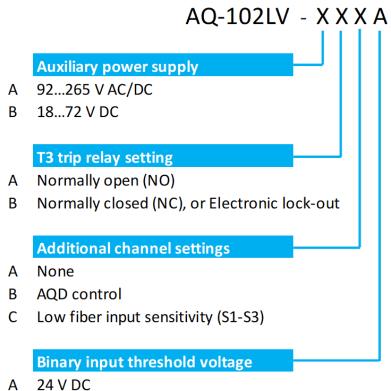
Instruction manual

Version: 1.04

Device dimensions (W × H × D)	50 × 157 × 160 mm
Weight	0.7 kg

# 15 Ordering information

#### AQ-102LV fiber optic loop sensor device



#### **Accessories**

Order code	Description	Note	Manufacturer
AX006	Wall mounting bracket	For AQ-103 and AQ-110x variants (MV and LV).	Arcteq Relays Ltd.
AX016	Wall mounting bracket	For AQ-101, AQ-101S and AQ-102 devices (MV and LV).	Arcteq Relays Ltd.
AX033	Sensor bracket		Arcteq Relays Ltd.

# 16 Contact and reference information

#### Manufacturer

Arcteq Relays Ltd.

### Visiting and postal address

Kvartsikatu 2 A 1 65300 Vaasa, Finland

#### Contacts

Phone: +358 10 3221 370

Website: <a href="mailto:arcteq.com">arcteq.com</a>

Technical support: <u>arcteq.com/support-login</u>

+358 10 3221 388 (EET 9:00 - 17.00)

E-mail (sales): sales@arcteq.fi